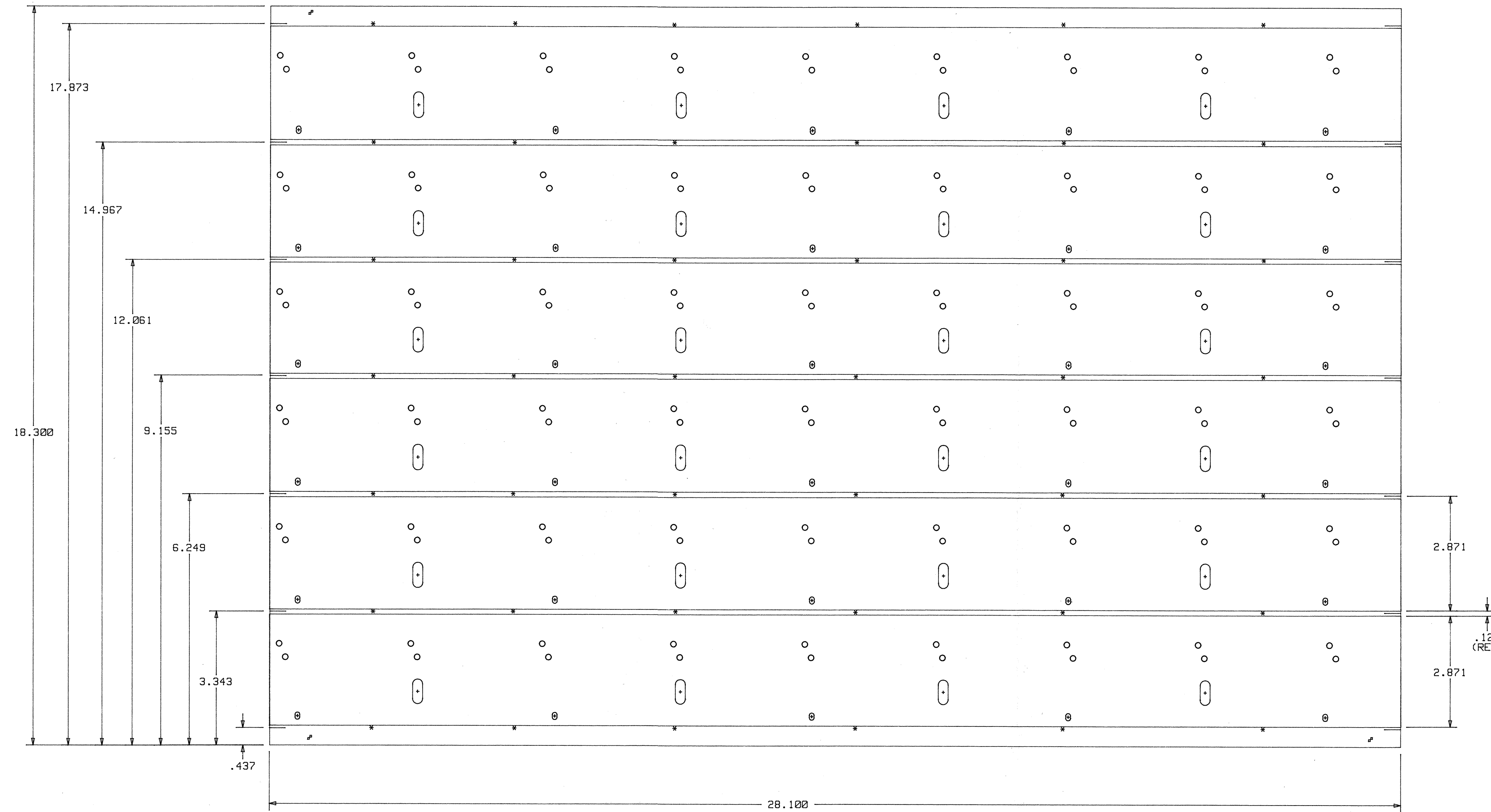


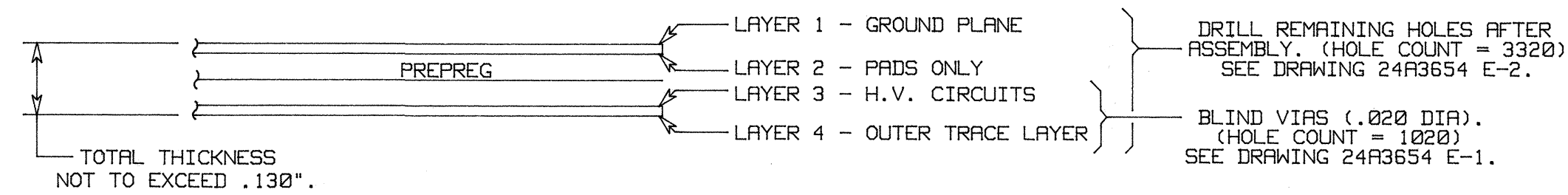
REV.	CHANGES	DRWN.	DATE	CHKD.	DATE

VIEWED FROM LAYER 1



NOTES:

- BOARD MATERIAL: .062 THICK EPOXY GLASS LAMINATE NEMA G10 PER MIL-P-13949G FL-GEN 062C-1/1-A1A (1 OZ COPPER EACH SIDE). THIS IS A 4 LAYER BOARD WITH TOTAL THICKNESS NOT TO EXCEED .130. WE WILL SUPPLY G10 MATERIAL.
- PREPREG THICKNESS TO BE DETERMINED BY MANUFACTURER PER IPC-L-105A OR MIL-P-13949G.
- BOARD PANEL SIZE IS 18.300 +/- .010 X 28.100 +/- .005. SINGLE BOARD SIZE IS 2.701 X 28.100 +/- .005. DIMENSIONS ARE IN INCHES.
- \* = APPROXIMATE PLACEMENT OF .050 TABS. SLOTS TO BE .125 WIDE.
- REFERENCE DRAWINGS:  
 24A3654 E-1 a000892e1 HOLE SCHEDULE (LAYERS 3 & 4 ONLY)  
 24A3654 E-2 a000892e2 HOLE SCHEDULE (LAYERS 1 THRU 4)  
 24A3654 M-1 a000892m1 BOARD OUTLINE - CUTOUTS



D I S T		TITLE		STAR TPC	
S T		II:		INNER SECTOR ELECTRONICS	
S T		III:		ANODE WIRE MOUNT BOARD - PANEL OF 6	
S T		IV:		BOARD OUTLINE - (A000892U2)	
DRAWN BY	8052-24	DRWN. CHECKED	DATE	LAWRENCE BERKELEY LABORATORY	
DATE	NO. RECD.	APPROVED	DATE	UNIVERSITY OF CALIFORNIA	
ENGINEER	JIM HUNTER	FILE NO.	SIZE	DRAWING NO.	REV.
DEL. TO	SCALE NONE	a000892m2	4	24A3654 M-2	SHEET 2 OF 2
			E2, -C2, R19		